

#### N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

BV <sub>DSS</sub>	RDS(ON) Max	I <sub>D</sub> T <sub>C</sub> = +25°C
700V	$0.6\Omega$ @ $V_{GS} = 10V$	11A

# **Features and Benefits**

- Low On-Resistance
- High BV<sub>DSS</sub> Rating for Power Application
- Low Input Capacitance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

# **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Motor Control
- Backlighting
- AC-DC Converters

#### **Mechanical Data**

- Case: TO251 (Type TH3)
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 <a>3</a>
- Weight: 0.33 grams (Approximate)

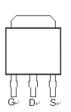




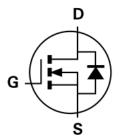




**Bottom View** 



Top View Pin Configuration



Internal Schematic

### Ordering Information (Note 4)

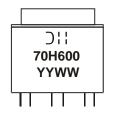
Part Number	Case	Packaging	
DMJ70H600SH3	TO251 (Type TH3)	75 Pieces / Tube	

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**

TO251 (Type TH3)



7H = Manufacturer's Marking
70H600 = Product Type Marking Code
YYWW = Date Code Marking
YY or YY = Last Two Digits of Year (ex: 17 = 2017)
WW or WW = Week Code (01 to 53)



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	700	V
Gate-Source Voltage		V <sub>GSS</sub>	±30	V
Continuous Drain Current (Note 5) V <sub>GS</sub> = 10V	$T_C = +25$ °C $T_C = +100$ °C	I <sub>D</sub>	11 7	А
Maximum Body Diode Forward Current (Note 6)		Is	1.8	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	11	Α
Avalanche Current (Note 7)	L = 60mH	I <sub>AS</sub>	1.5	Α
Avalanche Energy (Note 7)	L = 60mH	E <sub>AS</sub>	67.5	mJ
Peak Diode Recovery dv/dt (Note 7)		dv/dt	5	V/ns

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_C = +25$ °C	D-	113	- W
Total Fower Dissipation (Note 3)	T <sub>C</sub> = +100°C	$P_{D}$	45	
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	57	°C/W	
Thermal Resistance, Junction to Case (Note 5)	R <sub>0JC</sub>	1.1	C/VV	
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

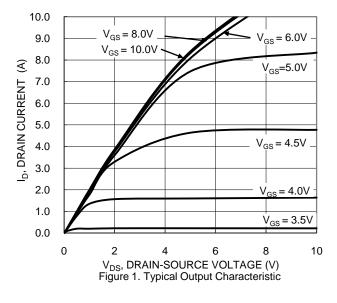
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	700	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μA	V <sub>DS</sub> = 700V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	$I_{GSS}$	_	_	100	nA	$V_{GS} = \pm 30V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	2	2.9	4	٧	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		0.5	0.6	Ω	$V_{GS} = 10V, I_D = 2.4A$	
Diode Forward Voltage	V <sub>SD</sub>	_	0.9	1.2	V	$V_{GS} = 0V, I_{S} = 4.6A$	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	Ciss		643	_		$V_{DS} = 25V$ , $f = 1MHz$ , $V_{GS} = 0V$	
Output Capacitance	Coss	_	524	_	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	_	13.5	_			
Gate Resistance	Rg	_	3.6	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge	Qg	_	18.2	_		V <sub>DD</sub> = 380V, I <sub>D</sub> = 4.6A, V <sub>GS</sub> = 10V	
Gate-Source Charge	Q <sub>gs</sub>	_	2.5	_	nC		
Gate-Drain Charge	Q <sub>gd</sub>	_	8.5	_		VGS = 10V	
Turn-On Delay Time	t <sub>D(ON)</sub>		11	_		$V_{DD} = 380V, V_{GS} = 10V,$ $R_g = 25\Omega, I_D = 4.6A$	
Turn-On Rise Time	t <sub>R</sub>	_	22	_	ns		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	85	_			
Turn-Off Fall Time	t <sub>F</sub>	_	23	_			
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	193	_	ns	1- 40 dl/dt 1000/up	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>		1.6		μC	I <sub>S</sub> = 4A, dI/dt = 100A/µs	

Notes:

- 5. Device mounted on infinite heatsink.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 7. Guaranteed by design. Not subject to production testing.
  8. Short duration pulse test used to minimize self-heating effect.







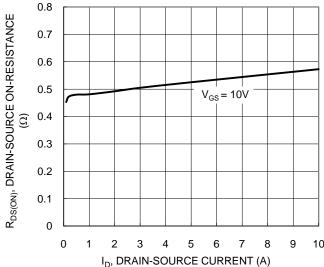


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

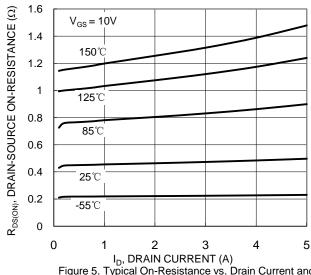
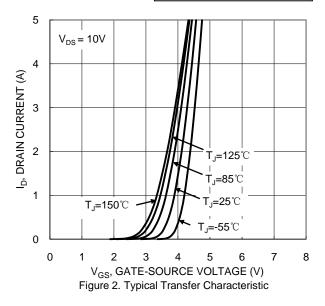
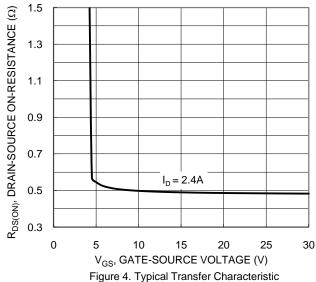


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





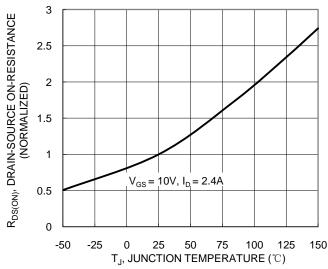


Figure 6. On-Resistance Variation with Temperature



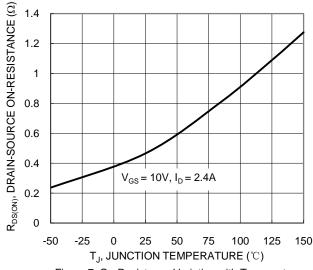
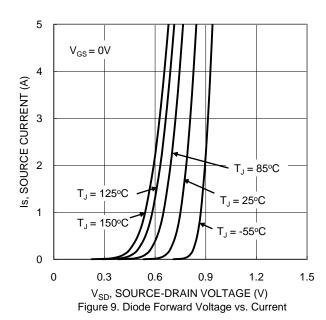
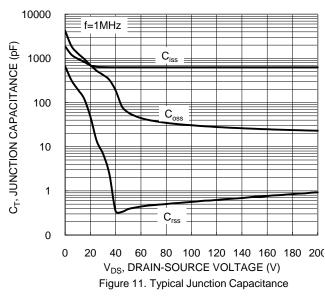


Figure 7. On-Resistance Variation with Temperature





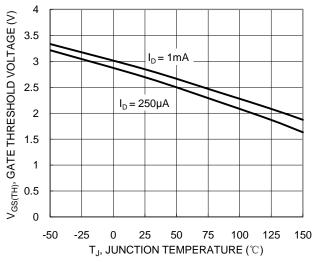


Figure 8. Gate Threshold Variation vs. Junction Temperature

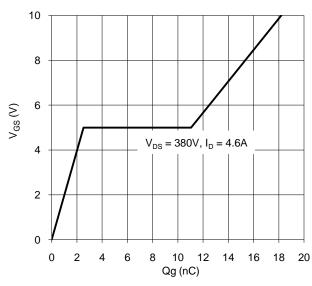
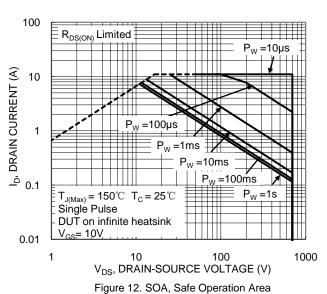


Figure 10. Gate Charge





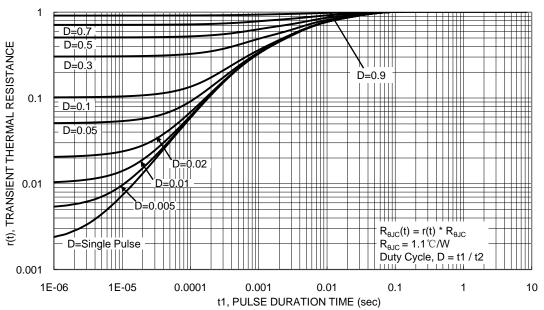


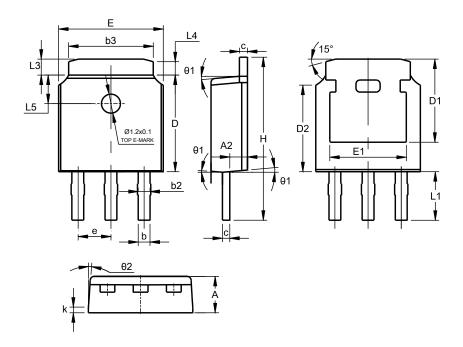
Figure 13. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TO251 (Type TH3)



TO251						
(Type TH3)						
Dim	Min	Max	Тур			
Α	2.20	2.40	2.30			
A2	0.97	1.17	1.07			
b	0.68	0.90	0.78			
b2	0.76	0.95	0.84			
b3	5.20	5.50	5.33			
С	0.43	0.63	0.53			
D	5.98	6.22	6.10			
D1	5	.30 RE	F			
D2	5.26 5.66		5.46			
е	2.	286 BS	C			
Е	6.40	6.80	6.60			
E1	4.63	5.03	4.83			
Н	9.40 9.85		9.62			
k	C	).40REF	=			
L1	2.30	2.70	2.50			
L3	0.88 1.28		1.02			
L4	0.75 REF					
L5	1.65	1.95	1.80			
θ1	5° 9° 7'		7°			
θ2	5° 9° 7°					
All Dimensions in mm						



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